

RELIABILITY REPORT FOR

DS1233, Rev B2

Dallas Semiconductor

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Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products and processes:

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport/dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

```
AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
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Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is defined by the failure mechanism is designed.

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

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AfV = exp(B*(Vs - Vu))

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
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The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

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Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
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Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 132693 FITS: 0.9

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.5 Volts

The reliability data follows. A the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available.

Device Information:

Process: 1P, 1M, 0.8um,Neg ZTC P1R,PdpID,Low Vts,BPSG ILO, N+ESDII,

Passivation: Passivation w/Nov TEOS Oxide-Nitride

Die Size: 39 x 29

Number of Transistors: 0

Interconnect: Aluminum / 1% Silicon / 0.5% Copper

Gate Oxide Thickness: 175 Å

ELECTRICAL CHARACTERIZATION								
DESCRIPTION	DATE CODE CONDITION READ		POINT	QUANTITY	FAILS			
ESD SENSITIVITY	0147	EOS/ESD S5.1 HBM 500 VOLTS	2	PUL'S	3	0		
ESD SENSITIVITY	0147	EOS/ESD S5.1 HBM 1000 VOLTS	2	PUL'S	3	0		
ESD SENSITIVITY	0147	EOS/ESD S5.1 HBM 2000 VOLTS	2	PUL'S	3	0		
ESD SENSITIVITY	0147	EOS/ESD S5.1 HBM 4000 VOLTS	2	PUL'S	3	3		
ESD SENSITIVITY	0147	EOS/ESD S5.1 HBM 8000 VOLTS	2	PUL'S	3	3		
LATCH-UP	0147	JESD78, I-TEST 125C			3	0		
LATCH-UP	0147	JESD78, Vsupply TEST 125C			3	0		
				Tot	al:	6		

OPERATING LIFE						
DESCRIPTION	DATE COD	E CONDITION	READ	POINT	QUANTITY	FAILS
INFANT LIFE	9607	125C, 7.0 VOLTS	48	HRS	315	0
HIGH VOLTAGE LIFE	9607	125C, 7.0 VOLTS	1000	HRS	116	0
INFANT LIFE	9616	125C, 7.0 VOLTS	48	HRS	192	0
HIGH VOLTAGE LIFE	9616	125C, 7.0 VOLTS	1000	HRS	114	0
INFANT LIFE	9638	125C, 7.0 VOLTS	48	HRS	198	0
HIGH VOLTAGE LIFE	9638	125C, 7.0 VOLTS	1000	HRS	117	0
HIGH VOLTAGE LIFE	9731	125C, 7.0 VOLTS	1000	HRS	153	0
INFANT LIFE	9734	125C, 7.0 VOLTS	48	HRS	315	0

TEMPERATURE CYC	1 F				
HIGH VOLTAGE LIFE	0222	125C, 7.0 VOLTS	1000	HRS 7 Total:	78 0 1
HIGH VOLTAGE LIFE	0218	125C, 6.0 VOLTS			0
HIGH VOLTAGE LIFE	0210	125C, 7.0 VOLTS		-	78 0
HIGH VOLTAGE LIFE	0147	125C, 6.0 VOLTS	1000	HRS 8	0 0
HIGH VOLTAGE LIFE	0029	125C, 7.0 VOLTS	1000	HRS 11	4 0
INFANT LIFE	0029	125C, 7.0 VOLTS	48	HRS 18	3 0
HIGH VOLTAGE LIFE	0014	125C, 7.0 VOLTS	1000	HRS 11	4 0
INFANT LIFE	0014	125C, 7.0 VOLTS	48	HRS 18	6 0
HIGH VOLTAGE LIFE	0013	125C, 7.0 VOLTS	1000	HRS 7	2 0
INFANT LIFE	0013	125C, 7.0 VOLTS	48	HRS 14	4 0
HIGH VOLTAGE LIFE	0012	125C, 7.0 VOLTS	1000	HRS 7	2 0
INFANT LIFE	0012	125C, 7.0 VOLTS	48	HRS 14	4 0
HIGH VOLTAGE LIFE	9939	125C, 7.0 VOLTS	1000	HRS 25	6 1
HIGH VOLTAGE LIFE	9937	125C, 7.0 VOLTS	1000	HRS 11	4 0
INFANT LIFE	9937	125C, 7.0 VOLTS	48	HRS 18	
HIGH VOLTAGE LIFE	9935	125C, 7.0 VOLTS		HRS 14	
HIGH VOLTAGE LIFE	9925	125C, 7.0 VOLTS		HRS 19	
INFANT LIFE	9925	125C, 7.0 VOLTS	48	HRS 76	
HIGH VOLTAGE LIFE	9831	125C, 7.0 VOLTS		HRS 22	
HIGH VOLTAGE LIFE	9807	125C, 7.0 VOLTS		HRS 11	
INFANT LIFE	9807	125C, 7.0 VOLTS	48	HRS 31	
HIGH VOLTAGE LIFE	9734	125C, 7.0 VOLTS	1000	HRS 11	6 0

TEMPERATURE CYCLE							
	DESCRIPTION	DATE CODE	CONDITION	READ	POINT	QUANTITY	FAILS
	TEMP CYCLE	9607	-55C TO 125C	1000	CYS	77	0
	TEMP CYCLE	9616	-55C TO 125C	1000	CYS	77	0
	TEMP CYCLE AUTOCLAVE	9638	-55C TO 125C 121C, 2 ATM STEAM, UNBIASED	1000 1096	CYS HRS	77 35	0 0
	TEMP CYCLE	9734	-55C TO 125C	1000	CYS	77	0
	TEMP CYCLE	9807	-55C TO 125C	1000	CYS	77	0
	TEMP CYCLE	9937	-55C TO 125C -55C TO 125C	1000 1000		77 77	0 0
	TEMP CYCLE	0012	-55C TO 125C	1000	CYS	77	0
	TEMP CYCLE	0013	-55C TO 125C	1000	CYS	77	0
	TEMP CYCLE	0014	-55C TO 125C	1000	CYS	77	0
	TEMP CYCLE	0029	-55C TO 125C	1000	CYS	77	0
	TEMP CYCLE	0222	-55C TO 125C	1000	CYS	77	0

TEMPERATURE HUM	IIDITY BIAS					
DESCRIPTION	DATE CODE	CONDITION	REA	DPOINT	QUANTITY	FAILS
HAST	9607	120C, 85%R.H.,5.5V	200	HRS	77	0
BIASED MOISTURE	9616	85/85, 5.5 VOLTS	959	HRS	78	0
BIASED MOISTURE	9638	85/85, 5.5 VOLTS	959	HRS	81	0
HAST	9734	120C, 85%R.H.,5.5V	100	HRS	77	0
HAST	9807	120C, 85%R.H.,5.5V	100	HRS	77	0
BIASED MOISTURE	9937	85/85, 5.5 VOLTS	959	HRS	72	1
BIASED MOISTURE	0012	85/85, 5.5 VOLTS	959	HRS	72	0
BIASED MOISTURE	0013	85/85, 5.5 VOLTS	959	HRS	72	0
BIASED MOISTURE	0014	85/85, 5.5 VOLTS	959	HRS	72	0
BIASED MOISTURE	0029	85/85, 5.5 VOLTS	959	HRS	75	0
BIASED MOISTURE	0222	85/85, 5.5 VOLTS	959	HRS	78	0
				To	tal:	1
UNBIASED MOISTUR	E RESISTAN	CE				
DESCRIPTION	DATE CODE	CONDITION	REA	DPOINT	QUANTITY	FAILS
AUTOCLAVE	9607	121C, 2 ATM STEAM, UNBIASED	168	HRS	45	0
AUTOCLAVE	9616	121C, 2 ATM STEAM, UNBIASED	168	HRS	45	0
AUTOCLAVE	9638	121C, 2 ATM STEAM, UNBIASED	168	HRS	45	0
HAST, NO BIAS	9734	120C, 85% R.H.	200	HRS	43	0
HAST, NO BIAS	9807	120C, 85% R.H.	200	HRS	44	0
ALITOCL AVE						_
AUTOCLAVE	9937	121C, 2 ATM STEAM, UNBIASED	168	HRS	45	0
AUTOCLAVE	9937 0012	121C, 2 ATM STEAM, UNBIASED 121C, 2 ATM STEAM, UNBIASED	168 168	HRS HRS	45 45	0
					_	
AUTOCLAVE	0012	121C, 2 ATM STEAM, UNBIASED	168	HRS	45	0
AUTOCLAVE AUTOCLAVE	0012 0013	121C, 2 ATM STEAM, UNBIASED 121C, 2 ATM STEAM, UNBIASED	168 168	HRS HRS	45 45	0
AUTOCLAVE AUTOCLAVE	0012 0013 0014	121C, 2 ATM STEAM, UNBIASED 121C, 2 ATM STEAM, UNBIASED 121C, 2 ATM STEAM, UNBIASED	168 168 168	HRS HRS HRS	45 45 45	0 0

FAILURE RATE: MTTF (YRS): 132693 FITS: 0.9